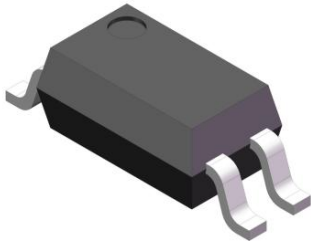
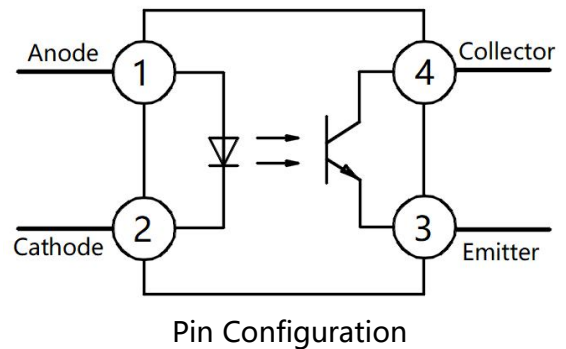


Product packaging logic diagram



SSOP4



Features

- Current transfer ratio(CTR: 80~600% at $I_F = 5\text{mA}$, $V_{CE} = 5\text{V}$)
- High isolation voltage between input and output ($V_{iso} = 3750\text{Vrms}$)
- Collector - emitter breakdown voltage $BV_{CEO} \geq 80\text{V}$
- Operating Temperature: $-55^\circ\text{C} \sim 100^\circ\text{C}$
- Environmentally friendly products, compliant with CQC, UL, and VDE requirements

Mechanical Data

- Case: SSOP4
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solder ability-per MIL-STD-202, Method 208

Applications

- It is widely used in the feedback control loop of switching power supply and the isolation between the main circuit and the control circuit, ensuring the stability of the output voltage and quickly transmitting the fault signal to trigger the protection mechanism in the case of overload or short circuit.
- In applications such as PLCs (Programmable Logic Controllers), motor drives, and sensor interfaces, it is used for signal isolation to prevent high-voltage noise from interfering with low-voltage control logic.
- For signal isolation in serial communication interfaces (e.g., RS-232,) to improve anti-interference capability.
- Consumer electronics: household appliances, smart home devices (smart lighting, smart sockets), computers and peripherals (printers, monitors), etc.
- Lighting control: AC transistor optocoupler is suitable for dimming control, smart switching, and wireless control, supporting AC input.



Ordering Information

XL
 3H7
 (X)
 (X)
 (X) -
 (U)
 (N)
 (Y)

① ② ③ ④ ⑤ ⑥ ⑦ ⑧

- ① Brand(XL)
- ② Product series(3H7)
- ③ Package type(None:(SSOP4))
- ④ Halogen option(None :Halogen free)
- ⑤ CTR Bank(A,B or None)
- ⑥ Lead frame (None: Copper)
- ⑦ Customer option 1 (0-9 or A- Z or none)
- ⑧ Customer option 2 (0-9 or A- Z or none)

Part Number	Package	Shipping Quantity	Marking Code
XL3H7A	SSOP4	5000pcs / Tape & Reel	XL3H7A

Marking Information

- " XL" denotes brand.
- " 3H7" denotes Product series.
- " X" denotes CTR Rank : A, B , None.
- " Y" denotes Year : A(2024), B(2025), C(2026)
- " WW" denotes Week' s number .
- " N" denotes the day of Week.



Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Input	Forward Current	I _F	50	mA
	Peak Forward Current *1	I _{FM}	1	A
	Reverse Voltage	V _R	6	V
	Power Dissipation	P _D	70	mW
Output	Collector Power Dissipation	P _C	150	mW
	Collector Current	I _C	50	mA
	Collector-Emitter Voltage	V _{CEO}	80	V
	Emitter-Collector Voltage	V _{ECO}	7	V

Thermal Characteristics

Parameter	Symbol	Value	Unit
Total Power Dissipation	P _{TOT}	200	mW
Isolation Voltage *2	V _{ISO}	3750	V _{rms}
Rated Impulse Isolation Voltage	V _{IOTM}	5000	V
Rated Repetitive Peak Isolation Voltage	V _{IORM}	600	V
Thermal Resistance Junction-to-Air	R _{θJA}	430	°C/W
Thermal Resistance Junction-to-Case	R _{θJC}	350	°C/W
Thermal Resistance Junction-to-Lead	R _{θJL}	368	°C/W
Operating Temperature	T _{OPR}	-55 ~ +110	°C
Storage Temperature Range	T _{STG}	-55 ~ +125	°C
Soldering Temperature *3	T _{SOL}	260	°C

Notes:

1. Pulse width ≤ 1μs, Duty ratio: 0.001
2. 40 to 60% RH, AC for 1 minute
3. For 10 seconds

Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Parameter		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V _F	I _F = 20mA	-	1.2	1.4	V
	Peak Forward Voltage	V _{FM}	I _{FM} = 0.5A	-	-	3.0	V
	Reverse Current	I _R	V _R = 4V	-	-	10	μA
	Input Capacitance	C _{in}	V _R = 0V, f = 1kHz	-	30	250	pF
Output	Collector-Emitter Dark Current	I _{CEO}	V _{CE} = 20V, I _F = 0	-	-	100	nA
	Collector-Emitter Breakdown Voltage	BV _{CEO}	I _C = 0.1mA, I _F = 0	80	-	-	V
	Emitter-Collector Breakdown Voltage	BV _{ECO}	I _E = 10μA, I _F = 0	7	-	-	V
Transfer Characteristics	Collector Current	I _C	I _F = 5mA, V _{CE} = 5V	2.5	-	30	mA
	Current Transfer Ratio	CTR	I _F = 5 mA, V _{CE} = 5V	80	-	600	%
	Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _F = 20mA, I _C = 1mA	-	0.1	0.2	V
	Isolation Resistance	R _{ISO}	V _{IO} = 500Vdc 40~60% R.H.	1×10 ¹²	-	-	Ω
	Isolation current	R _{ISC}	DC6000V, 40~60%R.H	-	-	2	μA
	Floating Capacitance	C _{IO}	V _{IO} = 0, f = 1MHz	-	0.6	1.0	pF
	Cut-off frequency	f _c	V _{CE} = 5V, I _C = 2mA R _L =100Ω, -3dB	-	80	-	kHz
	Turn On Time	T _{on}	V _{CE} =2V, R _L = 100Ω	-	4	18	μs
	Turn Off Time	T _{off}	I _C =2mA	-	3	18	

Rank Table of Current Transfer Ratio CTR

Rank Mark	Min. (%)	Max. (%)	Condition
A	80	160	I _F = 5 mA, V _{CE} = 5V
B	130	260	
C	200	400	
D	300	600	
No mark	80	600	

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Fig.1 Allowable Forward Current vs. Ambient Temperature

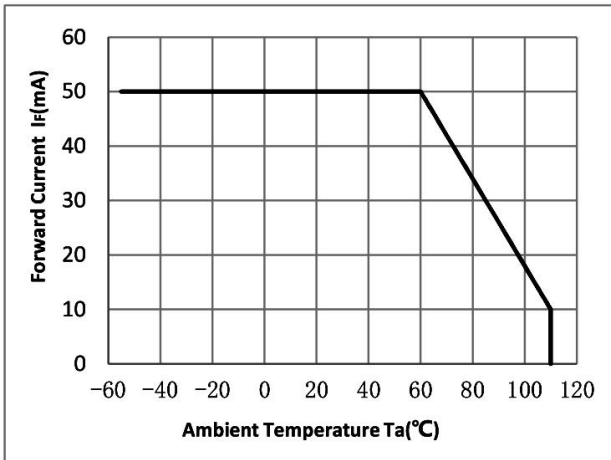


Fig.2 Allowable collector power dissipation vs. Ambient Temperature ($^\circ\text{C}$)

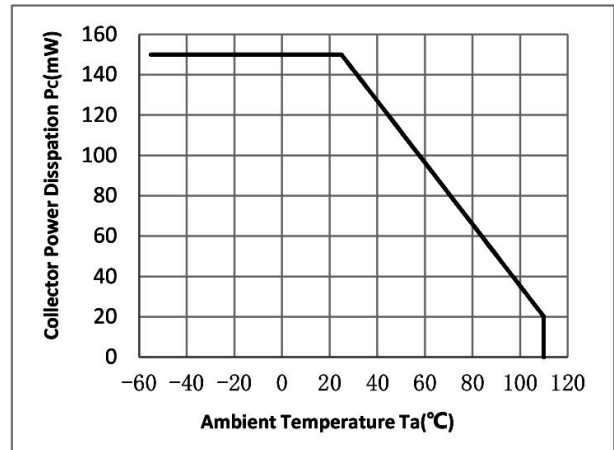


Fig.3 Relative Current Transfer Ratio vs. Forward Current

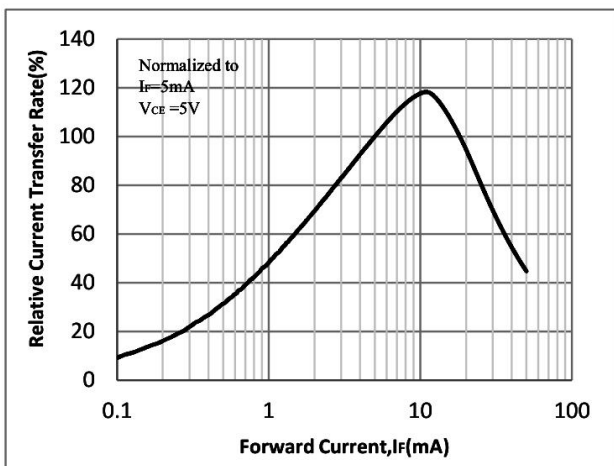


Fig.4 Forward Current vs. Forward Voltage

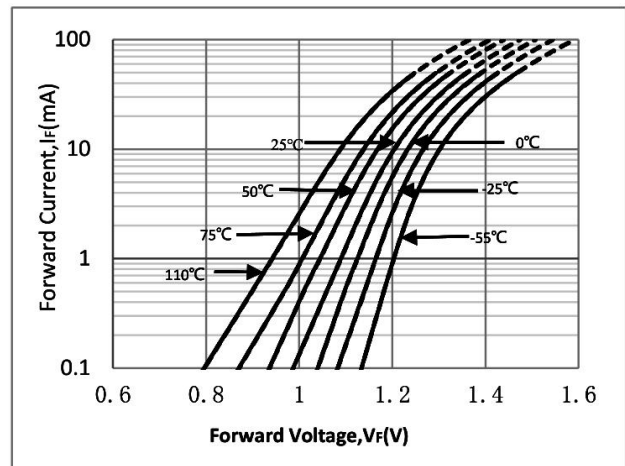


Fig.5 Collector Current vs. Collector-emitter Voltage

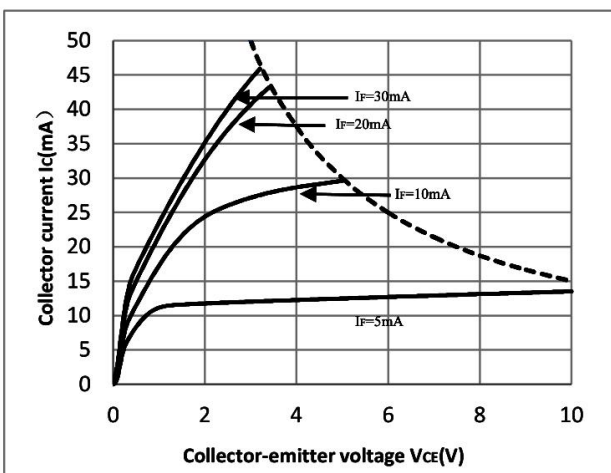
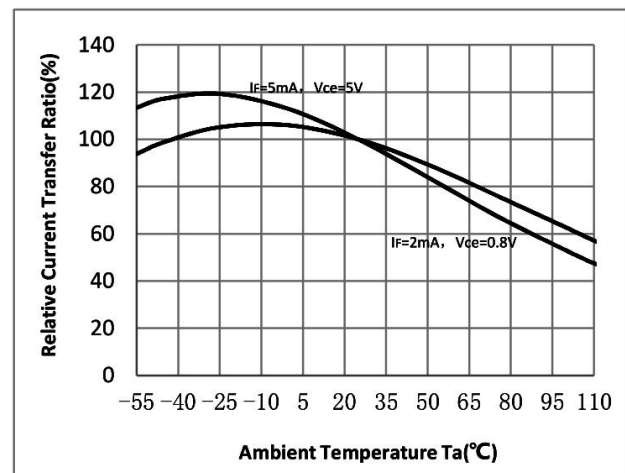


Fig.6 Relative Current Transfer Ratio vs. Ambient Temperature



Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Fig.7 Collector-emitter Saturation Voltage vs. Ambient Temperature

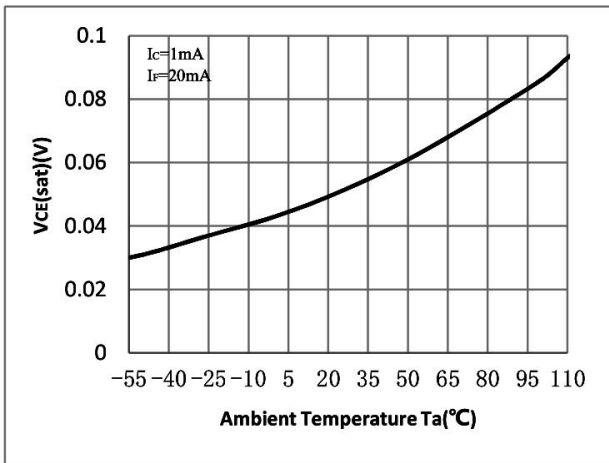


Fig.8 Collector Dark Current vs. Ambient Temperature

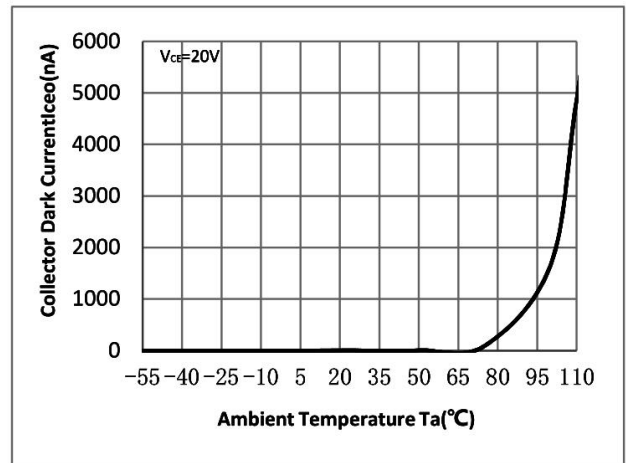


Fig.9 Response Time vs. Load Resistance

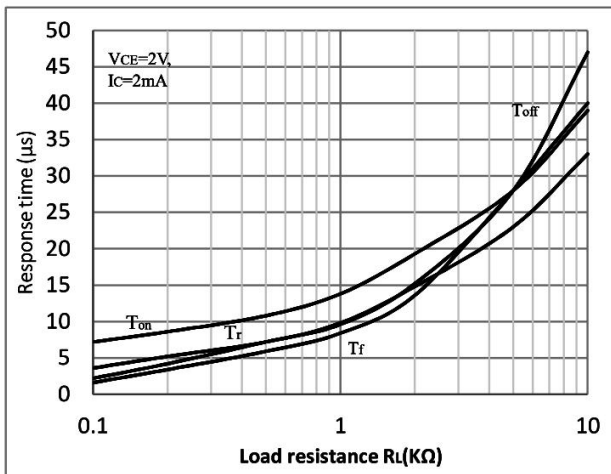


Fig.10 Frequency Response

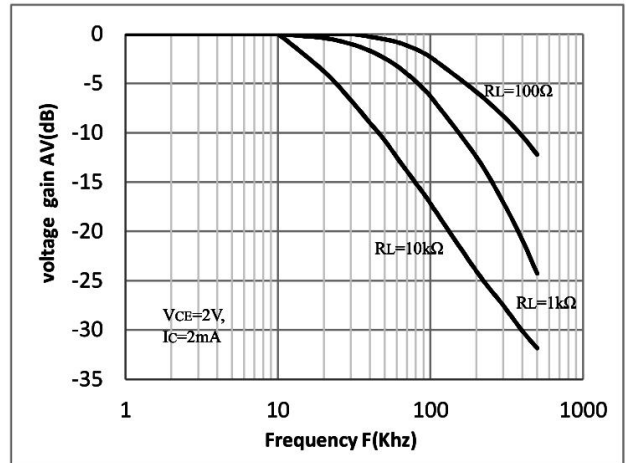


Fig.11 Collector-emitter Saturation Voltage vs. Forward Current

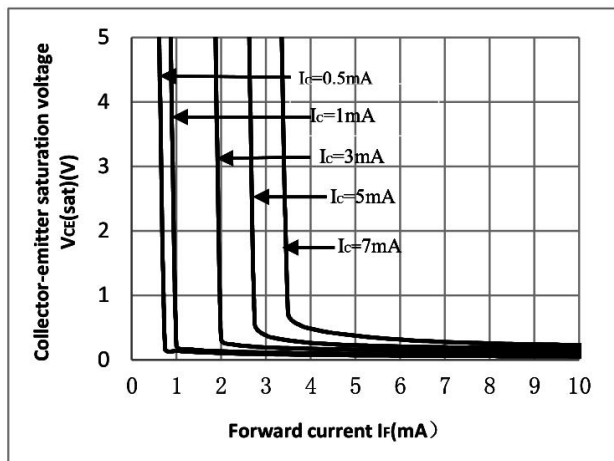
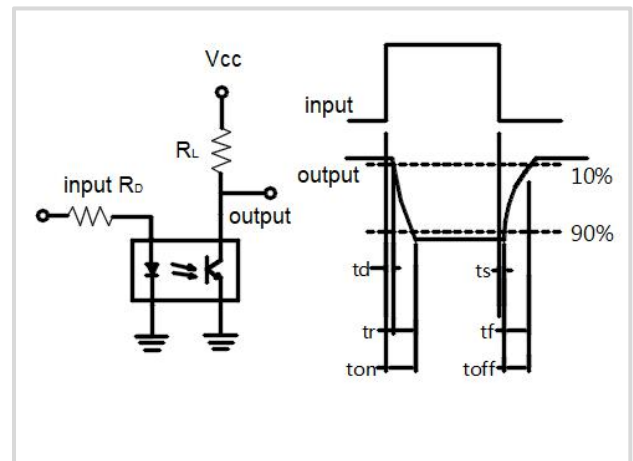
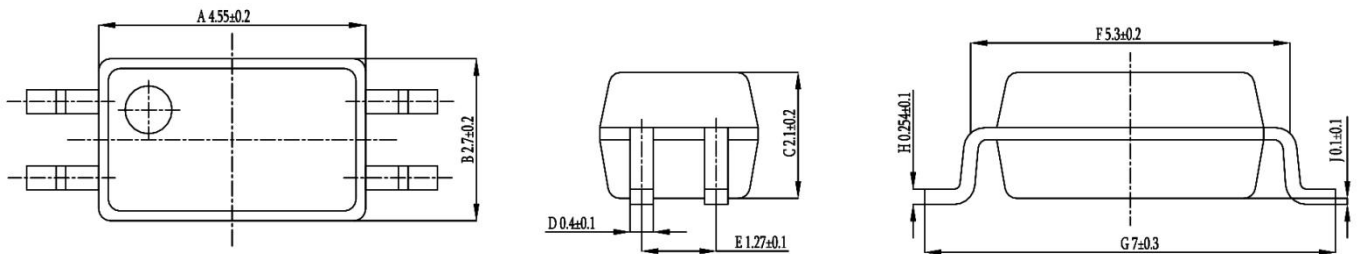


Fig.12 Switching Time Test Circuit & Waveforms

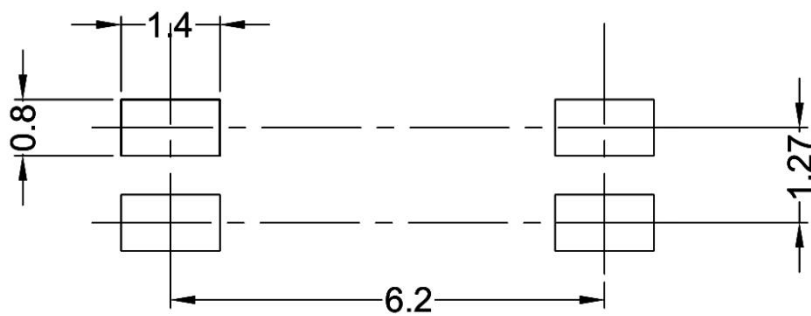


Package Outline Dimensions (unit: mm)

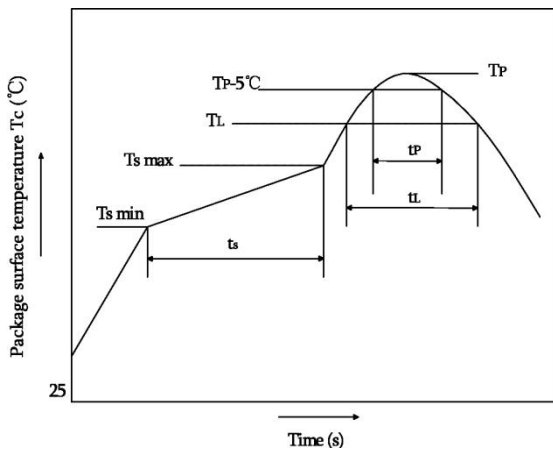
SSOP4



SOLDERING FOOTPRINT (unit: mm)



Reflow soldering

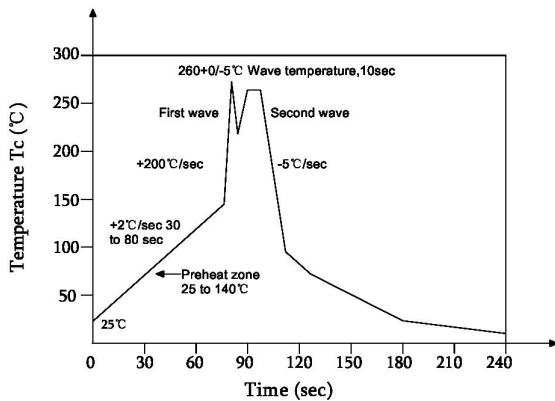


	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	s
Ramp-up rate(Tl to Tp)			3	°C/s
Liquidus temperature	Tl	217		°C
Time above Tl	tL	60	150	s
Peak temperature	Tp		260	°C
Time during which Tc is between (Tp-5) and Tp	tP		30	s
Ramp-down rate(Tp to Tl)			6	°C/s

Note:

Reflow soldering is recommended at the temperatures and times shown, no more than three times.

Wave soldering



Profile feature	
Average ramp-up rate	~200°C/s
Heating rate during preheat	1°C/s to 2°C/s typical; 4°C/s maximum
Final preheat temperature Ts	~130°C
Preheat time (25°C to Ts)	> 60s
Peak temperature Tp	260°C
Time within peak temperature tp	10s
Ramp-down rate	5°C/s maximum

Soldering with hand soldering iron

- A. Hand soldering iron is only used for product rework or sample testing.
- B. Hand soldering iron requirements: Temperature: 360 °C±5°C within 3s.

Packing

Package Type	Packing Form	Quantity per Tube & Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SSOP4	Reel(φ330mm)	5000 pcs/reel	2 reels /box	10 boxes /ctn	380*420mm	350*340*60mm	365*330*370mm	Leave 50 Spaces at the beginning and 100 Spaces at the end

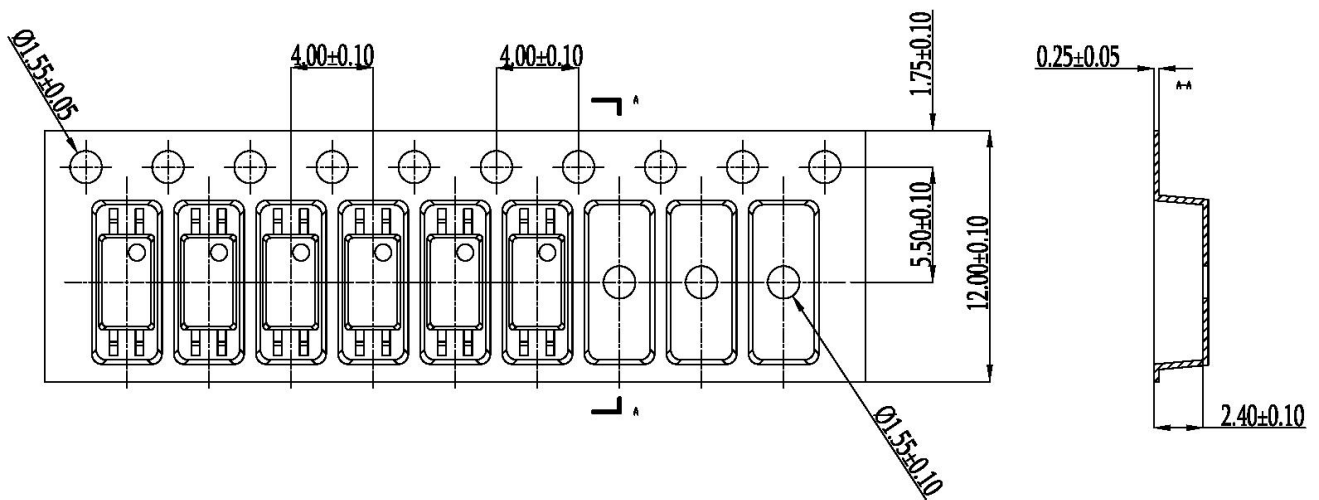
■ Summary table

■ SSOP4 (Reel)

Qty/reel: 5000 pcs. Qty/box: 10000 pcs.

Qty/ctn: 100000 pcs.

Schematic: (unit:mm)



Attention

- XINGLIGHT implements dynamic technical updates. Specifications are subject to change. Refer to the official website for the latest version.
- Users must strictly adhere to specified conditions. Failures caused by misuse (overload, high temperature, incompatible circuits) are excluded from warranty.
- Contact technical support for customized validation in critical applications (medical devices, industrial control).
- This document is valid until Dec 31, 2026. Updates will be notified on the official website.
- For further clarification on technical specifications or application solutions, please contact us through official channels.